

WHAT IS CLAIMED IS:

1. Automatic test equipment for testing a plurality of devices-under-test, each of the devices-under-test having a predetermined number of input/output contact points for receiving and outputting signals, said automatic test equipment including:  
a plurality of channel modules, each of the channel modules having a  
5 plurality of channels, each channel corresponding to one of the contact points; and  
programmable delay circuitry coupled to each channel module, the  
programmable delay circuitry including a deskew circuit shared by more than one of  
the channels of the coupled channel module.
2. Automatic test equipment according to claim 1 wherein:  
each channel module comprises an integrated circuit formed with more  
than one channel.
3. A method of calibrating channels of a parallel tester having calibration  
circuitry shared with tester channels, the method including the steps of:  
determining the level of accuracy required from the calibration  
circuitry to calibrate the channels;  
5 collecting deskew data for the channels;  
optimizing the collected deskew data; and  
storing the deskew data.
4. A method of calibrating channels of a parallel tester according to claim  
3 wherein said optimizing step includes:  
averaging the deskew data from more than one channel.
5. A method of calibrating channels of a parallel tester according to claim  
3 wherein said optimizing step includes:  
averaging the deskew data from all of the channels in parallel.
6. A method of calibrating channels of a parallel tester according to claim  
3 wherein said optimizing step includes:  
utilizing the individual deskew data for each channel.

7. A method of calibrating semiconductor tester channels for subsequently testing a plurality of DUTs, the tester channels being formed into modules, the channels of each module coupled to pin locations for different DUT locations, each module of channels having inputs coupled to shared calibration circuitry, the method including the steps of:

- selecting a set of DUT locations;
- identifying each tester channel from each module coupled to the selected DUT locations;
- collecting deskew data for each of the identified channels with the shared deskew circuitry;
- optimizing the collected deskew data;
- storing the optimized deskew data for use during device testing; and
- continuing the selecting, identifying, collecting, optimizing and storing steps until all of the tester channels are calibrated.

8. A method of calibrating semiconductor tester channels according to claim 7 wherein:

- the optimizing step includes averaging the collected deskew data for groups of channels.

9. A method of calibrating semiconductor tester channels according to claim 7 wherein:

- the optimizing step includes using the collected deskew data as the calibration data for each channel.

10. A method of testing a plurality of DUTs with a semiconductor tester, the tester including a plurality of channels formed into modules, the channels of each module coupled to pins of different DUTs, each module of channels having inputs coupled to a shared programmable delay circuit, the method including the steps of:

5                   selecting a group of DUTs to test;

                  identifying the channels from each module coupled to each pin of the selected DUTs;

                  loading optimized calibration data for the identified channels into the programmable delay circuit;

10                  testing the selected DUTs; and

                  continuing the selecting, identifying, loading and testing steps until all of the DUTs are tested.